**ON Semiconductor** ™

SWITCHMODE ™ II Series
NPN Silicon Power Transistors

The BUX 48/BUX 48A transistors are designed for high–voltage, high–speed, power switching in inductive circuits where fall time is critical. They are particularly suited for line–operated SWITCHMODE applications such as:

- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls
- Deflection Circuits

- Fast Turn–Off Times
  60 ns Inductive Fall Time — 25°C (Typ)
  120 ns Inductive Crossover Time — 25°C (Typ)
- Operating Temperature Range –65 to +200°C
- 100°C Performance Specified for:
  Reverse–Biased SOA with Inductive Loads
  Switching Times with Inductive Loads
  Saturation Voltage
  Leakage Currents (125°C)
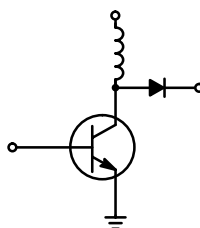
**15 AMPERES
NPN SILICON
POWER TRANSISTORS
400 AND 450 VOLTS
V(BR)CEO
850–1000 VOLTS
V(BR)CEX
175 WATTS**
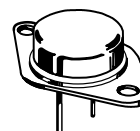
**CASE 1–07
TO–204AA
(TO–3)**

MAXIMUM RATINGS

Rating	Symbol	BUX48	BUX48A	Unit
Collector–Emitter Voltage	$V_{CEO(sus)}$	400	450	Vdc
Collector–Emitter Voltage (V_{BE} = – 1.5 V)	VCEX	850	1000	Vdc
Emitter Base Voltage	V_{EB}	7		Vdc
Collector Current — Continuous — Peak (1) — Overload	I_C I_{CM} I_{OI}	15 30 60		Adc
Base Current — Continuous — Peak (1)	I_B I_{BM}	5 20		Adc
Total Power Dissipation — T_C = 25°C — T_C = 100°C Derate above 25°C	P_D	175 100 1		Watts W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–65 to +200		°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8″ from Case for 5 Seconds	T_L	275	°C

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

ELECTRICAL CHARACTERISTICS ($T_C = 25°C$ unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS (1)						
Collector–Emitter Sustaining Voltage (Table 1) ($I_C = 200$ mA, $I_B = 0$) L = 25 mH BUX48 BUX48A		$V_{CEO(sus)}$	 400 450	 — —	 — —	Vdc
Collector Cutoff Current (V_{CEX} = Rated Value, $V_{BE(off)} = 1.5$ Vdc) (V_{CEX} = Rated Value, $V_{BE(off)} = 1.5$ Vdc, $T_C = 125°C$)		I_{CEX}	 — —	 — —	 0.2 2	mAdc
Collector Cutoff Current (V_{CE} = Rated V_{CEX}, $R_{BE} = 10$ Ω) $T_C = 25°C$ $T_C = 125°C$		I_{CER}	 — —	 — —	 0.5 3	mAdc
Emitter Cutoff Current ($V_{EB} = 5$ Vdc, $I_C = 0$)		I_{EBO}	—	—	0.1	mAdc
Emitter–Base Breakdown Voltage ($I_E = 50$ mA – $I_C = 0$)		$V_{(BR)EBO}$	7	—	—	Vdc
SECOND BREAKDOWN						
Second Breakdown Collector Current with Base Forward Biased		$I_{S/b}$		See Figure 12		
Clamped Inductive SOA with Base Reverse Biased		RBSOA		See Figure 13		
ON CHARACTERISTICS (1)						
DC Current Gain ($I_C = 10$ Adc, $V_{CE} = 5$ Vdc) BUX48 ($I_C = 8$ Adc, $V_{CE} = 5$ Vdc) BUX48A		h_{FE}	 8 8	 — —	 — —	
Collector–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 2$ Adc) ($I_C = 15$ Adc, $I_B = 3$ Adc) BUX48 ($I_C = 10$ Adc, $I_B = 2$ Adc, $T_C = 100°C$) ($I_C = 8$ Adc, $I_B = 1.6$ Adc) ($I_C = 12$ Adc, $I_B = 2.4$ Adc) BUX48A ($I_C = 8$ Adc, $I_B = 1.6$ Adc, $T_C = 100°C$)		$V_{CE(sat)}$	 — — — — — —	 — — — — — —	 1.5 5 2 1.5 5 2	Vdc
Base–Emitter Saturation Voltage ($I_C = 10$ Adc, $I_B = 2$ Adc) BUX48 ($I_C = 10$ Adc, $I_B = 2$ Adc, $T_C = 100°C$) ($I_C = 8$ Adc, $I_B = 1.6$ Adc) ($I_C = 8$ Adc, $I_B = 1.6$ Adc, $T_C = 100°C$) BUX48A		$V_{BE(sat)}$	 — — — —	 — — — —	 1.6 1.6 1.6 1.6	Vdc
DYNAMIC CHARACTERISTICS						
Output Capacitance ($V_{CB} = 10$ Vdc, $I_E = 0$, $f_{test} = 1$ MHz)		C_{ob}	—	—	350	pF

SWITCHING CHARACTERISTICS Resistive Load (Table 1)

			Symbol	Min	Typ	Max	Unit
Delay Time	$I_C = 10$ A, $I_B = 2$ A $I_C = 8$ A, $I_B = 1.6$ A Duty Cycle = 2%, $V_{BE(off)} = 5$ V $T_p = 30$ µs, $V_{CC} = 300$ V	BUX48 BUX48A	t_d	—	0.1	0.2	µs
Rise Time			t_r	—	0.4	0.7	
Storage Time			t_s	—	1.3	2	
Fall Time			t_f	—	0.2	0.4	

Inductive Load, Clamped (Table 1)

				Symbol	Min	Typ	Max	Unit
Storage Time	$I_C = 10$ A $I_{B1} = 2$ A	BUX48	($T_C = 25°C$)	t_{sv}	—	1.3	—	µs
Fall Time				t_{fi}	—	0.06	—	
Storage Time	$I_C = 8$ A $I_{B1} = 1.6$ A A	BUX48	($T_C = 100°C$)	t_{sv}	—	1.5	2.5	
Crossover Time				t_c	—	0.3	0.6	
Fall Time				t_{fi}	—	0.17	0.35	

(1) Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2%.
Vcl = 300 V, $V_{BE(off)} = 5$ V, Lc = 180µH

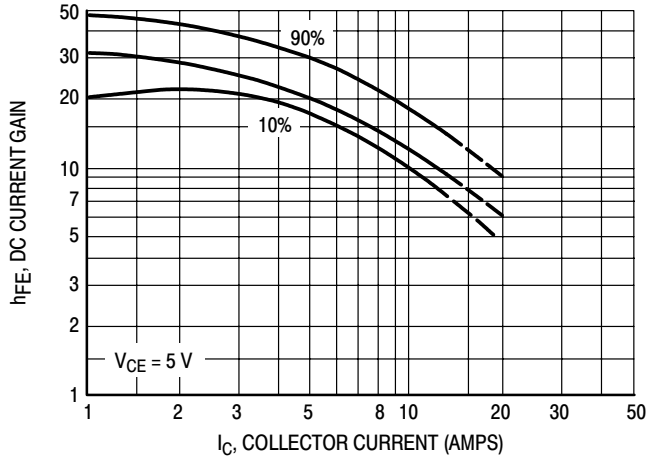---

DC CHARACTERISTICS

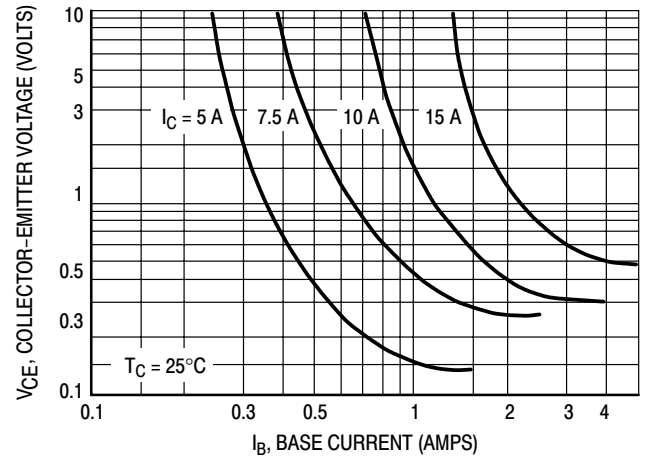**Figure 1. DC Current Gain**

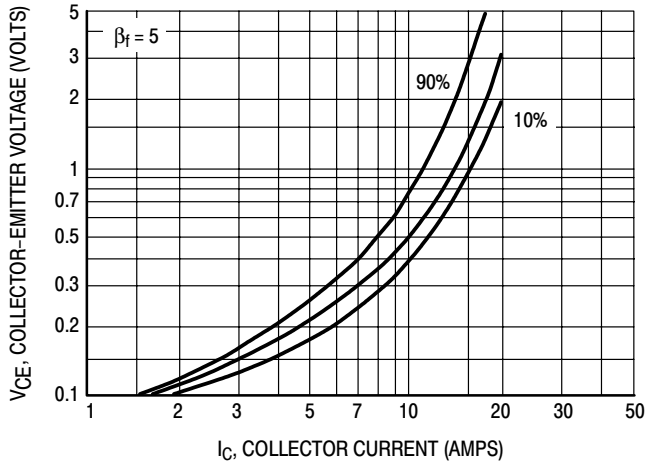**Figure 2. Collector Saturation Region**
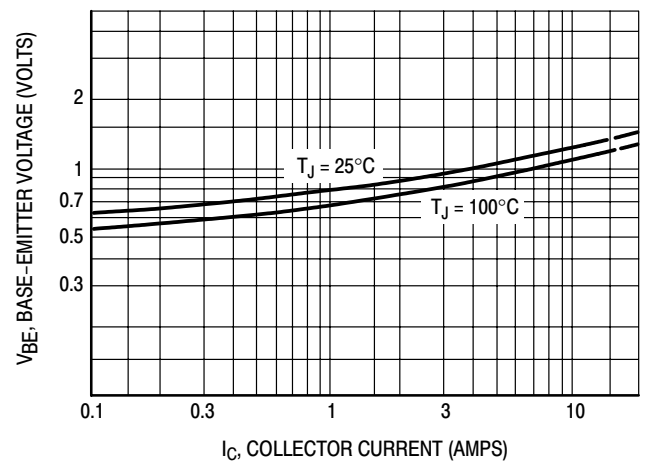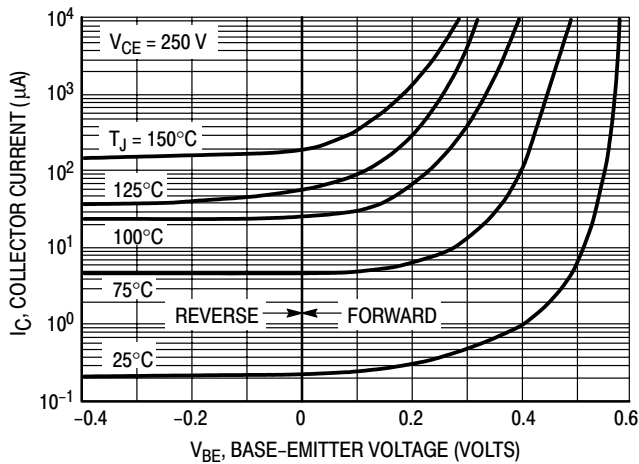
Figure 3. Collector–Emitter Saturation Voltage

Figure 4. Base–Emitter Voltage

Figure 5. Collector Cutoff Region
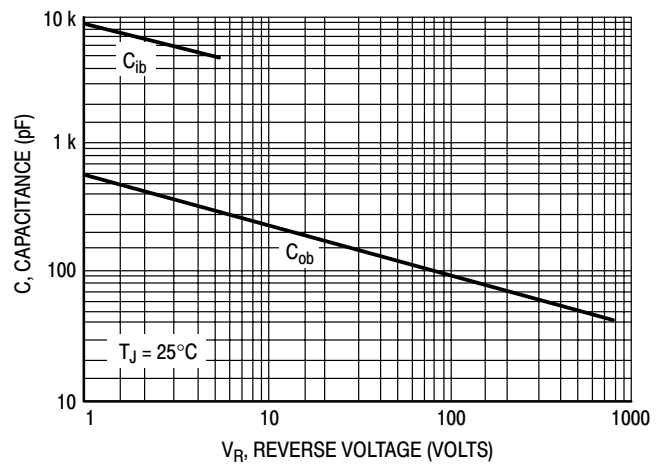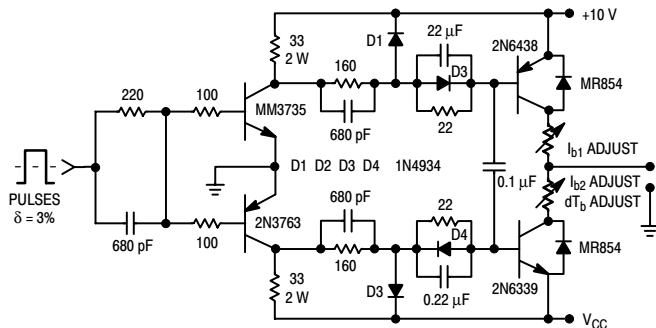
Figure 6. Capacitance
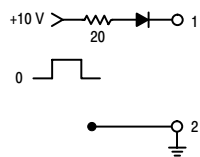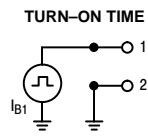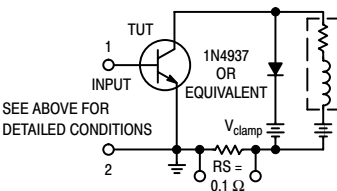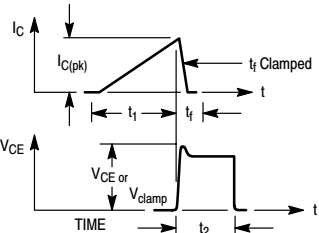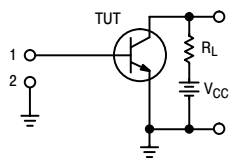
Table 1. Test Conditions for Dynamic Performance

|	$V_{CEO(sus)}$	RBSOA AND INDUCTIVE SWITCHING		RESISTIVE SWITCHING
INPUT CONDITIONS	+10 V —20— ▷ o 1 0 ⊓ o 2 ⏚ PW Varied to Attain I_C = 200 mA	PULSES δ = 3% 220, 100, MM3735, 33 2 W, 160, D1, 22 µF, D3, 2N6438, MR854 680 pF, 680 pF, 100, 2N3763, D1 D2 D3 D4 1N4934, 680 pF, 22, D4, 0.1 µF, I_{b1} ADJUST, I_{b2} ADJUST, dT_b ADJUST, MR854, 2N6339, 33 2 W, D3, 0.22 µF, +10 V, V_{CC}		**TURN–ON TIME** I_{B1} ⊓ o 1 o 2 I_{B1} adjusted to obtain the forced h_{FE} desired **TURN–OFF TIME** Use inductive switching driver as the input to the resistive test circuit.
CIRCUIT VALUES	L_{coil} = 25 mH, V_{CC} = 10 V R_{coil} = 0.7 Ω	L_{coil} = 180 µH R_{coil} = 0.05 Ω V_{CC} = 20 V	V_{clamp} = 300 V R_B ADJUSTED TO ATTAIN DESIRED I_{B1}	V_{CC} = 300 V R_L = 83 Ω Pulse Width = 10 µs
TEST CIRCUITS	**INDUCTIVE TEST CIRCUIT** TUT 1 o INPUT SEE ABOVE FOR DETAILED CONDITIONS 2 o 1N4937 OR EQUIVALENT R_{coil}, L_{coil} V_{clamp}, V_{CC} RS = 0.1 Ω	**OUTPUT WAVEFORMS** I_C, $I_{C(pk)}$, t_f Clamped, t_1, t_f, t V_{CE}, $V_{CE\ or}$ V_{clamp}, TIME, t_2, t	t_1 Adjusted to Obtain I_C $t_1 \approx \dfrac{L_{coil}\,(I_{Cpk})}{V_{CC}}$ $t_2 \approx \dfrac{L_{coil}\,(I_{Cpk})}{V_{Clamp}}$ Test Equipment Scope — Tektronix 475 or Equivalent	**RESISTIVE TEST CIRCUIT** TUT 1 o 2 o R_L, V_{CC}
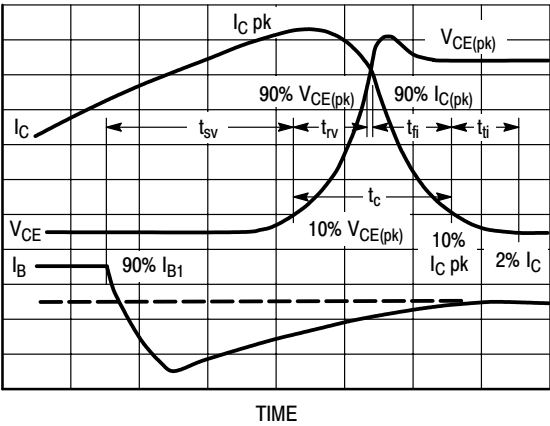
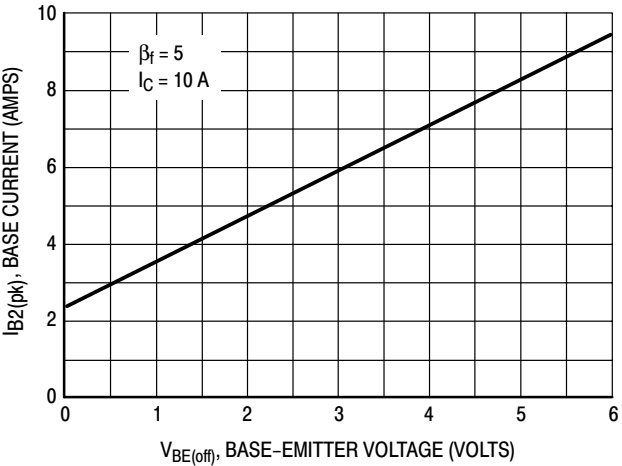Figure 7. Inductive Switching Measurements

Figure 8. Peak–Reverse Current

SWITCHING TIMES NOTE

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

t_{sv} = Voltage Storage Time, 90% I_{B1} to 10% V_{clamp}
t_{rv} = Voltage Rise Time, 10–90% V_{clamp}
t_{fi} = Current Fall Time, 90–10% I_C
t_{ti} = Current Tail, 10–2% I_C
t_c = Crossover Time, 10% V_{clamp} to 10% I_C

An enlarged portion of the inductive switching waveforms is shown in Figure 7 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN–222:

$$P_{SWT} = 1/2 \ V_{CC}I_C(t_c)f$$

In general, $t_{rv} + t_{fi} \simeq t_c$. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a "SWITCHMODE" transistor are the inductive switching speeds (t_c and t_{sv}) which are guaranteed at 100°C.
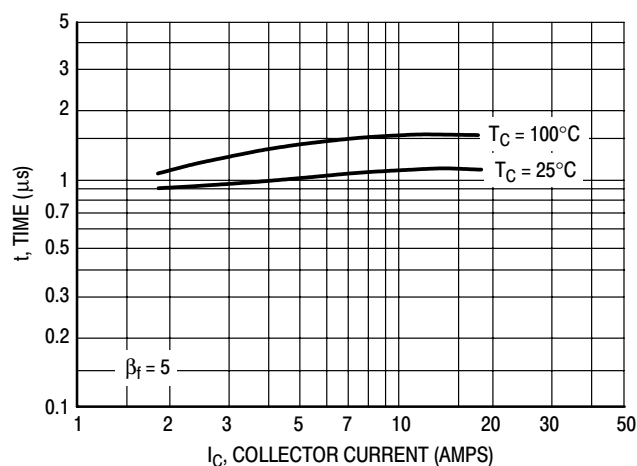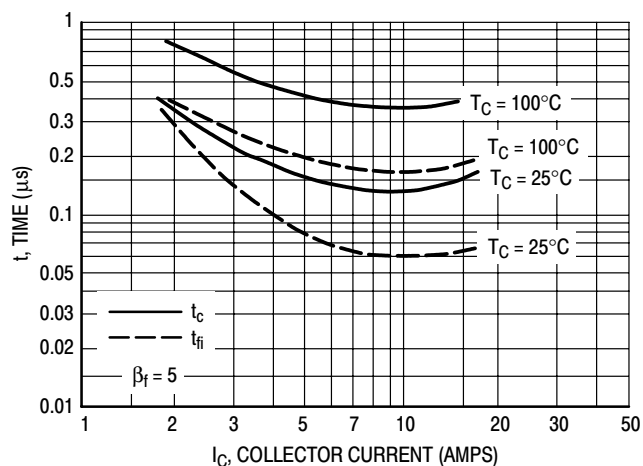
INDUCTIVE SWITCHING

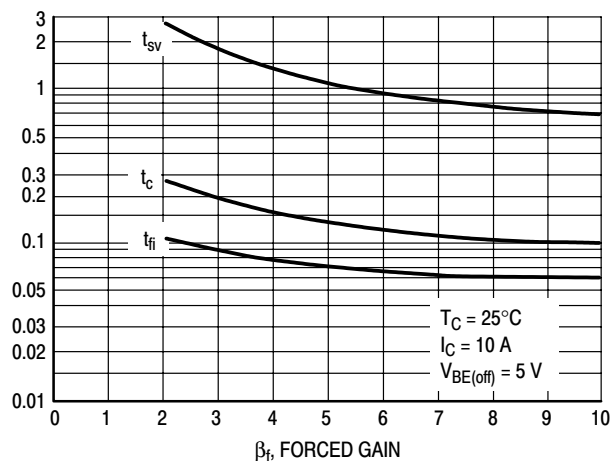Figure 9. Storage Time, t_{sv}

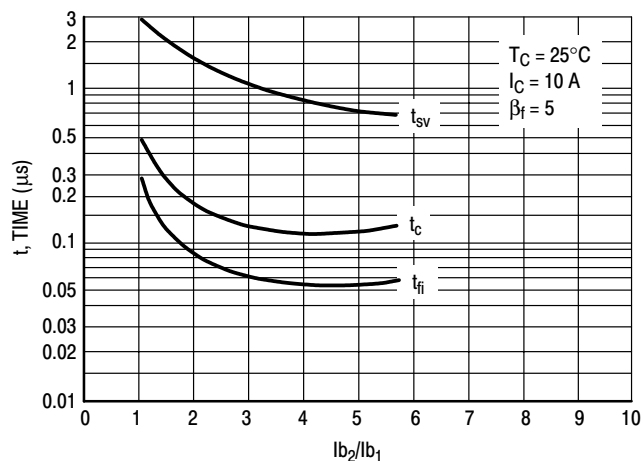Figure 10. Crossover and Fall Times

Figure 11. Turn–Off Times versus Forced Gain

Figure 12. Turn–Off Times versus Ib_2/Ib_1

The Safe Operating Area figures shown in Figures 12 and 13 are specified for these devices under the test conditions shown.
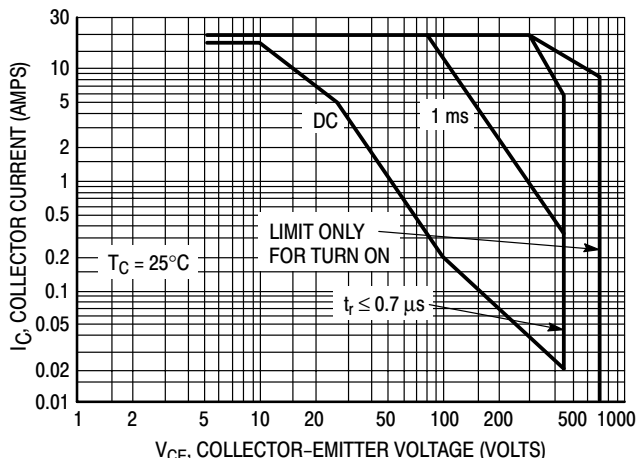

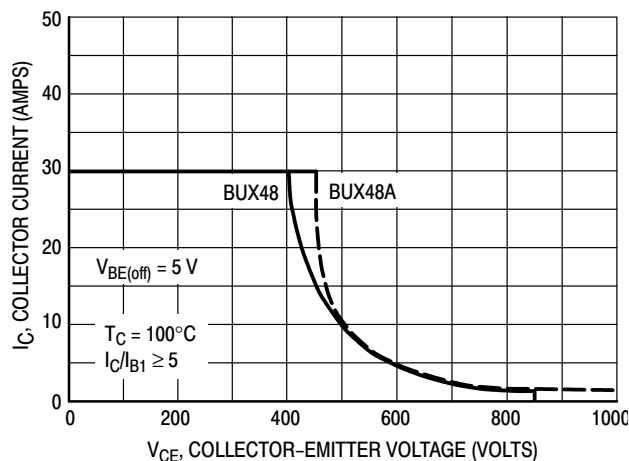**Figure 13. Forward Bias Safe Operating Area**

Figure 14. Reverse Bias Safe Operating Area

SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 13 is based on $T_C = 25°C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \geq 25°C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 13 may be found at any case temperature by using the appropriate curve on Figure 15.

$T_{J(pk)}$ may be calculated from the data in Figure 13. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn–off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage–current conditions during reverse biased turn–off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 14 gives RBSOA characteristics.
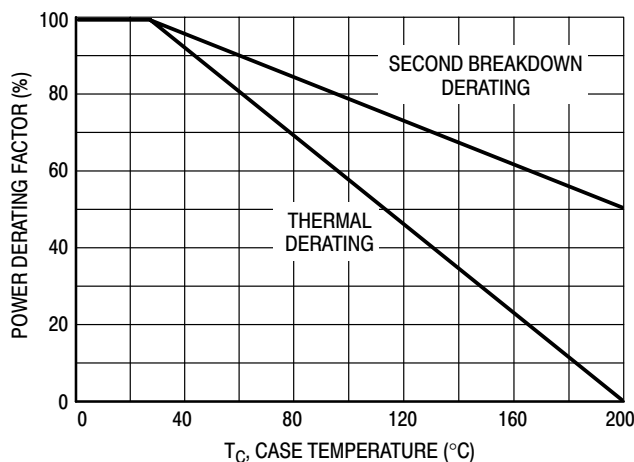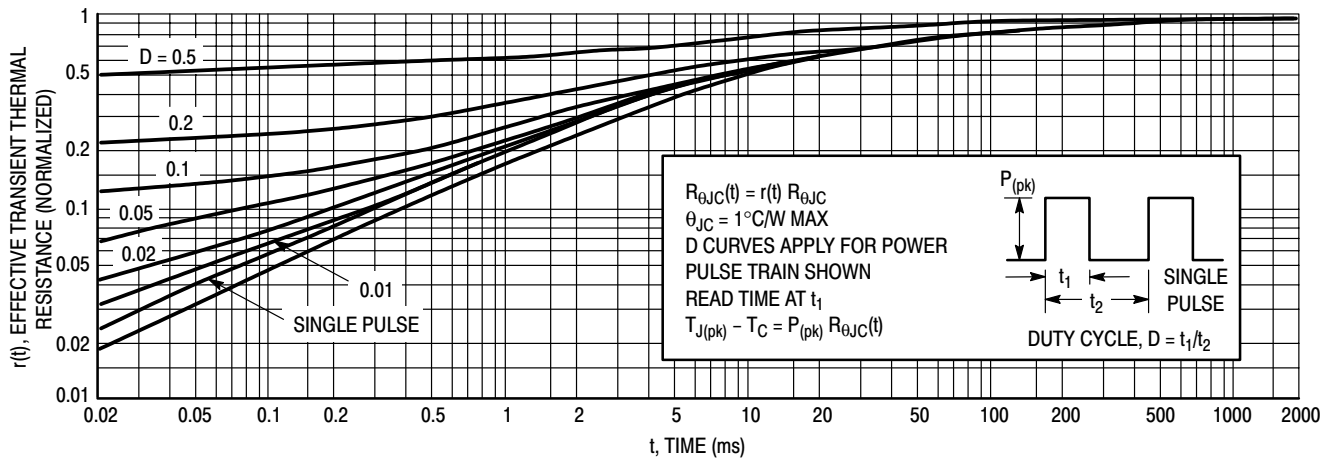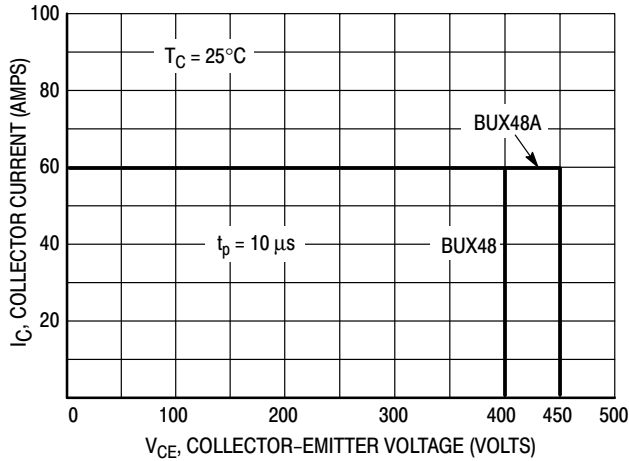

Figure 15. Power Derating

Figure 16. Thermal Response

OVERLOAD CHARACTERISTICS

**Figure 17. Rated Overload Safe Operating Area (OLSOA)**

OLSOA

OLSOA applies when maximum collector current is limited and known. A good example is a circuit where an inductor is inserted between the transistor and the bus, which limits the rate of rise of collector current to a known value. If the transistor is then turned off within a specified amount of time, the magnitude of collector current is also known.

Maximum allowable collector–emitter voltage versus collector current is plotted for several pulse widths. (Pulse width is defined as the time lag between the fault condition and the removal of base drive.) Storage time of the transistor has been factored into the curve. Therefore, with bus voltage and maximum collector current known, Figure 17 defines the maximum time which can be allowed for fault detection and shutdown of base drive.

OLSOA is measured in a common–base circuit (Figure 19) which allows precise definition of collector–emitter voltage and collector current. This is the same circuit that is used to measure forward–bias safe operating area.

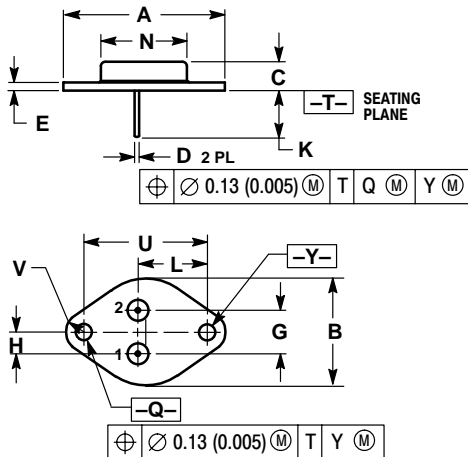**Figure 18. $I_C = f(dV/dt)$**
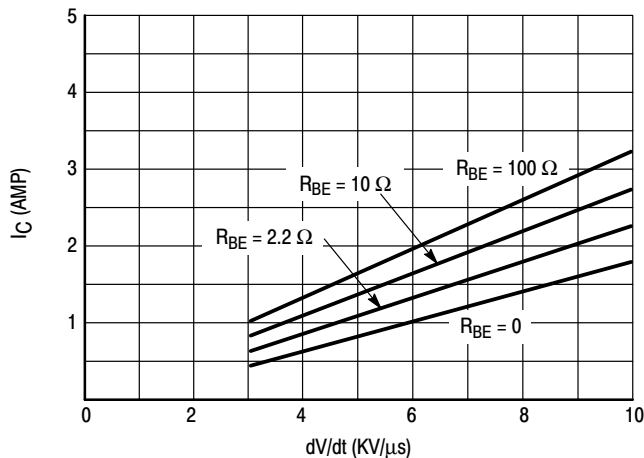
Notes:
- $V_{CE} = V_{CC} + V_{BE}$
- Adjust pulsed current source for desired I_C, t_p

Figure 19. Overload SOA Test Circuit
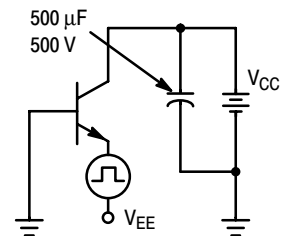
BUX48 BUX48A

PACKAGE DIMENSIONS

TO–204AA (TO–3)
CASE 1–07
ISSUE Z

NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ALL RULES AND NOTES ASSOCIATED WITH REFERENCED TO–204AA OUTLINE SHALL APPLY.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.550 REF		39.37 REF	
B	---	1.050	---	26.67
C	0.250	0.335	6.35	8.51
D	0.038	0.043	0.97	1.09
E	0.055	0.070	1.40	1.77
G	0.430 BSC		10.92 BSC	
H	0.215 BSC		5.46 BSC	
K	0.440	0.480	11.18	12.19
L	0.665 BSC		16.89 BSC	
N	---	0.830	---	21.08
Q	0.151	0.165	3.84	4.19
U	1.187 BSC		30.15 BSC	
V	0.131	0.188	3.33	4.77

SWITCHMODE is a trademark of Semiconductor Components Industries, LLC (SCILLC)

PUBLICATION ORDERING INFORMATION

NORTH AMERICA Literature Fulfillment:
 Literature Distribution Center for ON Semiconductor
 P.O. Box 5163, Denver, Colorado 80217 USA
 Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada
 Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada
 Email: ONlit@hibbertco.com
 Fax Response Line: 303–675–2167 or 800–344–3810 Toll Free USA/Canada

 N. American Technical Support: 800–282–9855 Toll Free USA/Canada

EUROPE: LDC for ON Semiconductor – European Support
 German Phone: (+1) 303–308–7140 (Mon–Fri 2:30pm to 7:00pm CET)
       Email: ONlit–german@hibbertco.com
 French Phone: (+1) 303–308–7141 (Mon–Fri 2:00pm to 7:00pm CET)
       Email: ONlit–french@hibbertco.com
 English Phone: (+1) 303–308–7142 (Mon–Fri 12:00pm to 5:00pm GMT)
       Email: ONlit@hibbertco.com

EUROPEAN TOLL–FREE ACCESS*: 00–800–4422–3781
       *Available from Germany, France, Italy, UK, Ireland

CENTRAL/SOUTH AMERICA:
 Spanish Phone: 303–308–7143 (Mon–Fri 8:00am to 5:00pm MST)
       Email: ONlit–spanish@hibbertco.com
 Toll–Free from Mexico: Dial 01–800–288–2872 for Access –
       then Dial 866–297–9322

ASIA/PACIFIC: LDC for ON Semiconductor – Asia Support
 Phone: 1–303–675–2121 (Tue–Fri 9:00am to 1:00pm, Hong Kong Time)
       Toll Free from Hong Kong & Singapore:
       001–800–4422–3781
 Email: ONlit–asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center
 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031
 Phone: 81–3–5740–2700
 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local
Sales Representative.